

客户图

NOTES:

1. FINISH:
 - 1.1 HOUSING: LCP BLACK,UL94V-0.
 - 1.2 CONTACT: PHOSPHOR BRONZE ,GOLD (SEE P/N) PLATED IN CONTACT AERA, 80u" MIN MATTE TIN PLATED IN SOLDER AREA,50u" MIN. NICKEL UNDERPLATED OVERALL.
2. ELECTRICAL:
 - 2.1 CURRENT RATING:2A;
 - 2.2 DIELECTRIC WITHSTANDING VOLTAGE: 500V AC/MINUTE.
 - 2.3 CONTACT RESISTANCE: 30mΩ MAX.
 - 2.4 INSULATION RESISTANCE: 300MΩ MIN.
 - 2.5 OPERATION TEMPERATURE:-55°C TO +125°C.
 - 2.6 VOLTAGE RATING 100V AC/DC
 - 2.7 Durability: 50 CYCLES.
- 3.ORDER INFORMATION:

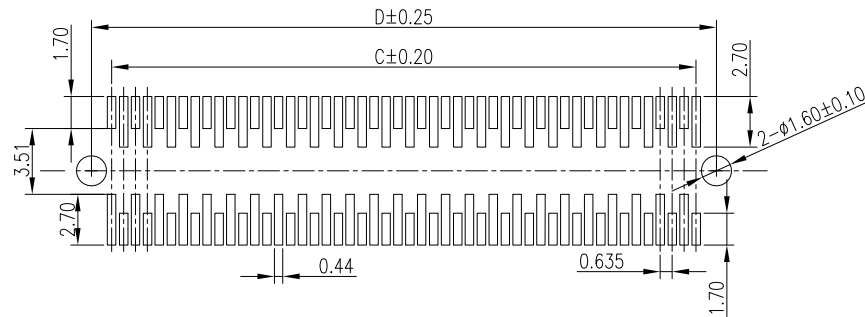
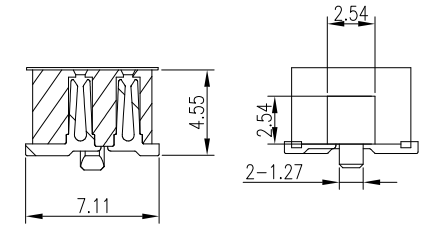
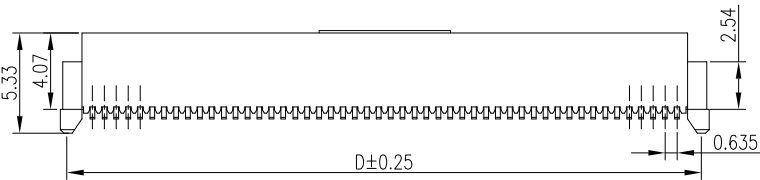
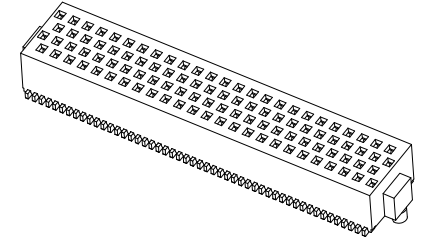
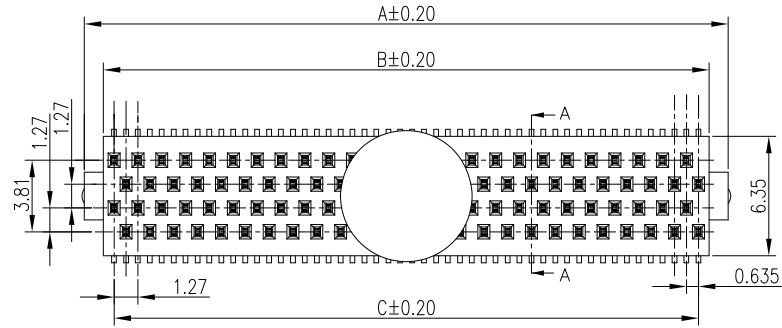
61F3 - F XXX XX 045 C 01

Pin数码	端子电镀:	塑胶高度:	包装方式:
010=2x5PIN	S1=1u" Gold/Tin	045=4.55mm	C=TRAY
.....	S2=3u" Gold/Tin		
200=2x100PIN	S3=5u" Gold/Tin		
	S4=10u" Gold/Tin		
	S5=15u" Gold/Tin		
	S6=30u" Gold/Tin		

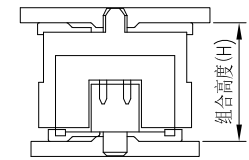
TABLE1:

No of Pin	A	B	C	D
020=4*5	8.89	6.85	5.08	7.87
040=4*10	15.24	13.20	11.43	14.22
060=4*15	21.59	19.55	17.78	20.57
080=4*20	27.94	25.90	24.13	26.92
100=4*25	34.29	32.25	30.48	33.27
120=4*30	40.64	38.60	36.83	39.62
140=4*35	46.99	44.95	43.18	45.97
160=4*40	53.34	51.30	49.53	52.32
180=4*45	59.69	57.65	55.88	58.67
200=4*50	66.04	64.00	62.23	65.02

TABLE
H
6.35
8.00
10.00
12.00



61F3-M-XXX-XX-XXX-C-01



61F3-F-XXX-XX-045-C-01

RECOMMENDED PCB LAYOUT(TOP SIDE)
PCB BOARD TOLFRANCF±0.05

				OPERATION		DRAW		WLY		2021.03.01		SOLEPIN 东莞市硕品电子有限公司 Professional connector manufacturer DONGGUAN SOLEPIN ELECTRONICS CO., LTD.			
				X.X	±0.40	DESIGN		Jensen		2021.03.01				SIZE	A4
				X.XX	±0.25	CHECK		Jack		2021.03.01		SHEET	1/1	TITLE:	1.27mm TOLC BTB 母头
AO		NEW		X.XXX	±0.15	APPROVE		Andy		2021.03.01		PROJ.	☉	DRAW NO.	SP-2010
REV	DATE	MODIFICATION DESCRIPTION		CHANGE	APPROVE	DIM.	TOL	UNIT	mm	SCALE	1:1				

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- 2.7 Durability: 50 CYCLES.

3.ORDER INFORMATION:

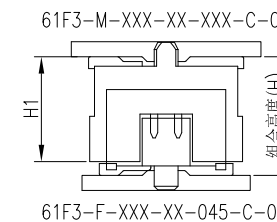
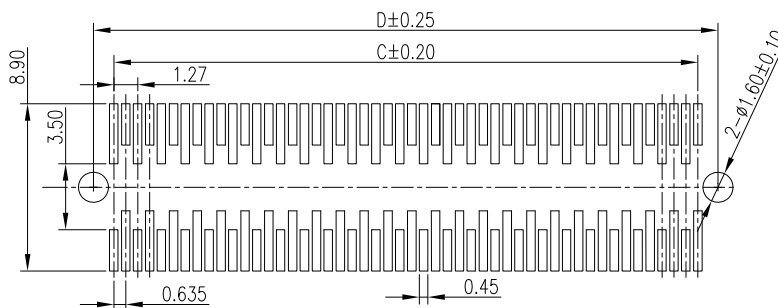
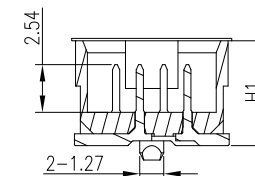
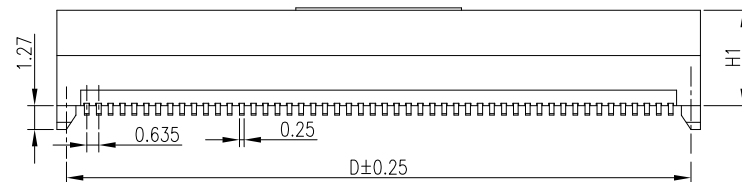
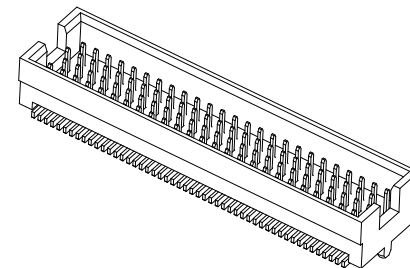
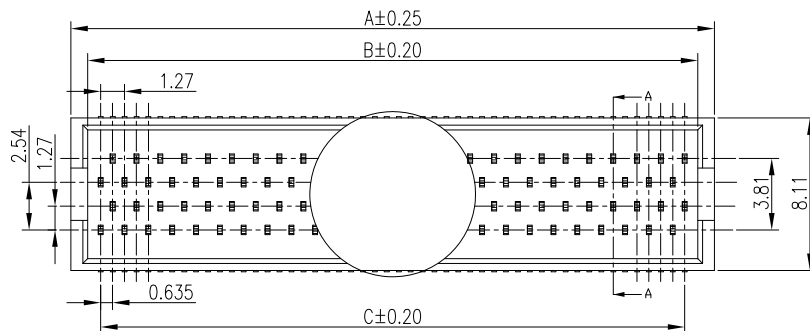
61F3 - M XXX XX XXX C 01

Pin数码	端子电镀:	塑胶高度:	包装方式:
010=2x5PIN	S1=1u" Gold/Tin	055=5.59	C=TRAY
.....	S2=3u" Gold/Tin	072=7.23	
200=2x100PIN	S3=5u" Gold/Tin	092=9.23	
	S4=10u" Gold/Tin	112=11.23	
	S5=15u" Gold/Tin		
	S6=30u" Gold/Tin		

TABLE1:

No of Pin	A	B	C	D
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180=4*45	59.69	57.91	55.88	58.67
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TABLE 1	
H	H1
6.35	5.59
8.00	7.23
10.00	9.23
12.00	11.23



RECOMMENDED PCB LAYOUT(TOP SIDE)
PCB BOARD TOLFRANCF±0.05

				OPERATION		DRAW		WLY		2021.03.01		SOLEPIN 东莞市硕品电子有限公司			
				X.X ±0.40		DESIGN		Jensen		2021.03.01		Professional connector manufacturer DONGGUAN SOLEPIN ELECTRONICS CO., LTD.			
				X.XX ±0.25		CHECK		Jack		2021.03.01		SIZE	A4	PART NO.	61F3-MXXXXXXXXX01
				X.XXX ±0.15		APPROVE		Andy		2021.03.01		SHEET	1/1	TITLE:	1.27mm TOLC BTB 公头
AO	NEW											PROJ.	∅	DRAW NO.	SP-2011
REV	DATE	MODIFICATION DESCRIPTION		CHANGE	APPROVE	DIM.	TOL	UNIT	mm	SCALE	1:1				